

12-09-1998

ETTER



Attorney Docket No.: 3962d-7138

To the Assistant Commissioner

100914404

Final documents or copy thereof.

1. Name of conveying party(ies):

TANAHASHI, Shigeo

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Kyocera Corporation
6, Takeda Tobadono-cho, Fushimi-ku
Kyoto-shi, Kyoto, Japan

Additional name(s) & address(es) attached? ☐ Yes ☒ No



3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: November 16, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: November 16, 1998

A. Patent Application No.(s) NOT ASSIGNED

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

09/204136

5. Name and address of party to whom correspondence concerning document should be mailed:

William H. Wright, Esq.
LOEB & LOEB LLP
10100 Santa Monica Blvd., 22nd Floor
Los Angeles, CA 90067-4164

6. Total number of applications and patents involved: [1]

7. Total fee (37 CFR 3.41) \$ 40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number:

12-1820

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

William H. Wright

Date: December 2, 1998

OMB No. 0651-0011 (exp. 4/94)

Mail documents to be recorded with required cover sheet information to:

Assistant Commissioner for Patents
Box Assignments
Washington, D.C. 20231

ASSIGNMENT

Attorney Docket No. 3962D-7138

(1-8) Insert Name(s) of Inventor(s)

(1) <u>Shigeo TANAHASHI</u>	(5) _____
(2) _____	(6) _____
(3) _____	(7) _____
(4) _____	(8) _____

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) Insert name of Assignee (9) KYOCERA CORPORATION

(10) Insert state of Incorporation of Assignee (10) a corporation of Japan

(11) Insert address of Assignee (11) of 6, Takeda Tobadono-cho, Fushimi-ku, Kyoto-shi, Kyoto, Japan
(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as

(12) Insert identification of Invention, such as Title, Case Number or Foreign Application Number (12) Multi-layer Circuit Substrate
(Case No. _____)
for which the undersigned has (have) executed an application for patent in the United States of America

(13) Insert Date of Signing of Application (13) on November 16, 1998

1) The undersigned agree(s) to execute all papers necessary in connection with an application in each of the countries of Schedule A and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not execute, any agreement in conflict herewith.

6) The undersigned hereby appoints STUART LUBITZ, Reg. No. 20,680; JAY M. FINKELSTEIN, Reg. No. 21,082; LOUIS A. MOK, Reg. No. 22,585; JOHN P. SCHERLACHER, Reg. No. 23,009; MICHAEL J. RAM, Reg. No. 26,379; HIDEO KODA, Reg. No. 27,729; R. DABNEY EASTHAM, Reg. No. 31,247; DON F. LIVORNESE, Reg. No. 32,040; GARY D. MANN, Reg. No. 34,867; JEFFREY M. HERSH, Reg. No. 35,541; WILLIAM H. WRIGHT, Reg. No. 36,312; JONATHAN Y. KANG, Reg. No. 38,199; DAVID L. LUBITZ, Reg. No. 38,229; WEI-NING YANG, Reg. No. 38,690 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

November 16,
Date: 1998 Signature of Inventor (Shigeo TANAHASHI) Shigeo Tanahashi

Date: _____ Signature of Inventor _____

Date: _____ Signature of Inventor _____

Date: _____ Signature of Inventor _____